连兴旺电子(深圳)有限公司

承认书

SPECIFICATIONS FOR APPROVAL

客户：
Customer：

客户料号：
Customer Part No:

公司料号：
Part No：LXW-SHLD-2xNPLT-N

产品名称：
Description：1.0 Pitch WTB SMT S/T TYPE

发行日期：
Issue Date:

客户签核 （Customer Approval）：

采购	品保	工程

内部签核 （Signature）：

核准	审核	制作
张旭明	蔡雍醇	谭泽沛

连兴旺电子(深圳)有限公司

LXWCONN ELECTRONICS (SHENZHEN) CO.,LTD

TEL：+86-0755 29591214 FAX：+86-0755 2369 8719

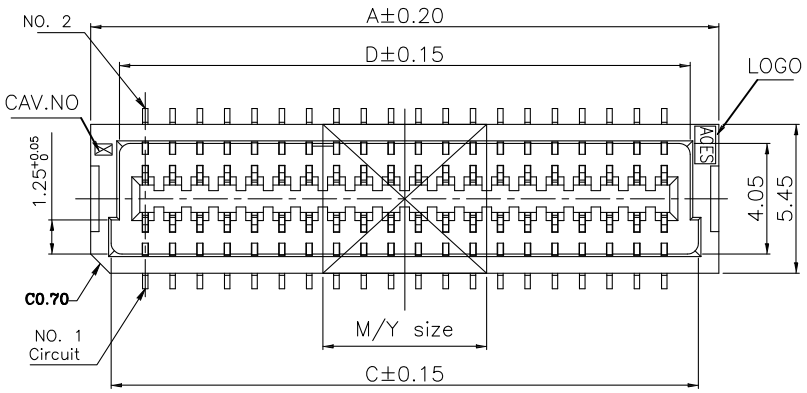
ADD：东莞市虎门镇新联社区高科一路 1 号钧益工业园 E 栋

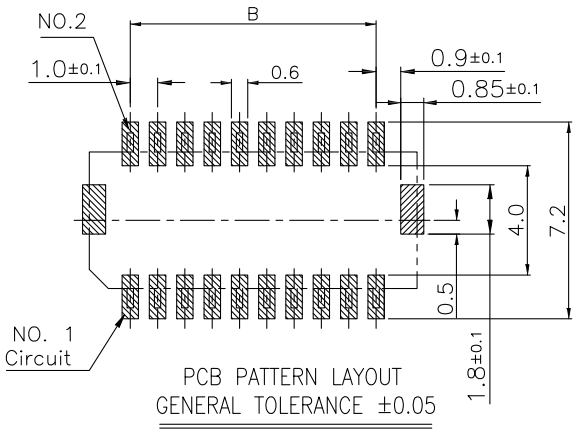
APPROVAL SPECIFICATIONS

Product name	P/N	Verszion	Document No.	Page
1.0 Pitch WTB SMT S/T TYPE	LXW-SHLD-2xNPLT-N	A/00		2 /3

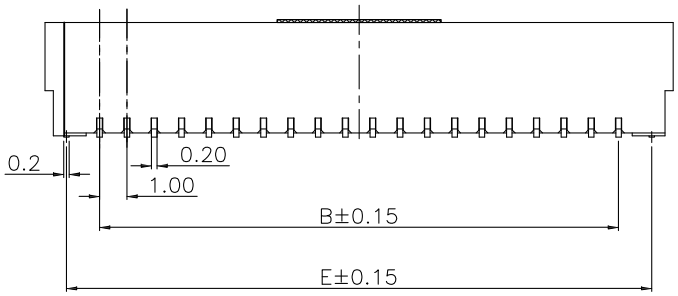
变更履历表：

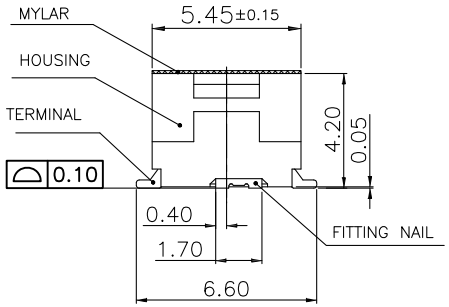
版本	变更记录	变更人	变 更 日 期
A/00			





NOTES:
1. MATERIAL:
   1.1 HOUSING: HALOGEN FREE THERMOPLASTIC, HIGH TEMP.UL94V-0; COLOR:NATURAL.
   1.2 CONTACT: COPPER ALLOY
   1.3 FITTING NAIL: COPPER ALLOY
2. FINISH:
   2.1 CONTACT & SOLDER:
   50~100u" NICKEL UNDER PLATING OVERALL
   4: 3u" GOLD PLATING ON CONTACT
   80~150u" PURE-TIN PLATING OVERALL
   1: GOLD FLASH ON CONTACT AND
   80~150u"(MIN) MATT-TIN PLATING OVERALL
   C: 15u" GOLD ON CONTACT AND
   80~150u"(MIN) MATT-TIN PLATING OVERALL
   2.2 FITTING NAIL:
   50~100u" NICKEL UNDER PLATING OVERALL
   80~150u" MATT TIN PLATING OVERALL
3. REFLOW SOLDER CAPABLE TO 260°C PER





CKT	Dim A	Dim B	Dim C	Dim D	Dim E	M/Y size
20	13.0	9.0	11.5	10.8	11.43	7.2
24	15.0	11.0	13.5	12.8	13.43	7.2
30	18.0	14.0	16.5	15.8	16.43	7.2
40	23.0	19.0	21.5	20.8	21.43	7.2
50	28.0	24.0	26.5	25.8	26.43	7.2

RoHS Compliant
2013/95/EC
Pb Process Capable

CUSTOMER DRAWING	LXW connectivity 连兴旺电子(深圳)有限公司 LXWCONN ELECTRONICS(SHENZHEN)CO.,LTD				
GENERAL TOLERANCE X.X ±0.40, X.XX ±0.25, X.XXX ±0.15, ANGLE ± 3°	DESIGN Tan 2026.06.06	TITLE 1.0 Pitch WTB SMT S/T TYPE			
	CHECKED Tan 2026.06.06	PART NO. LXW-SHLD-2xNPLT-N			
SIZE A4	APPROVAL Tan 2026.06.06	SCALE 1:1	UNITS MM	REV. A	SHEET 1 OF 1